#### **FEE TRANSMITTAL**

#### Electronic Version v08

Stylesheet Version v08.0

Title of Invention

[METHOD OF FABRICATING A SOLDER MASK AND STRUCTURE OF A SUBSTRATE]

Application Number:

Date:

First Named Applicant: Mr. Yi-Chuan Ding

Attorney Docket Number: 9246-US-PA

# **TOTAL FEE AUTHORIZED \$ 964**

Patent fees are subject to annual revisions on or about October 1st of each year.

Filing as large entity

# **BASIC FILING FEE**

Fee Description	Fee Code	Amount \$	Fee Paid \$			
Utility Filing Fee	1001	750	750			
Subtotal For Basic Filing Fees: \$ 750						

# **EXTRA CLAIM FEES**

Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$
Total Claims : 25	5	1202	18	90
Independent Claims: 4	1	1201	84	84
			Subtotal For Extra	Claims Fees: \$ 174

# **ASSIGNMENT FEES**

Fee Description	Property Number	Quantity	Fee Code	Amount \$	Fee Paid \$	
Recording Each Patent	00000000	1	8021	40	40	
Assignment Per Property Fee						
Subtotal For Additional Fees: \$40						

#### **AUTHORIZED BILLING INFORMATION**

The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:

Credit account number: 1007

Expiration Date (YYYYMMDD): 2005-12-31

Authorized name: YEH, WEN-HUNG

Billing address: 99999